

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Takashi HABU	10/24/2011
Fumiteru ASAI	10/24/2011
Tomokazu TAKAHASHI	10/24/2011
Eiichi IMOTO	10/19/2011
Yuta SHIMAZAKI	10/25/2011
RECEIVING PARTY DATA	
Name:	NITTO DENKO CORPORATION
Street Address:	1-1-2, Shimohozumi
City:	Ibaraki-shi, Osaka
State/Country:	JAPAN
Postal Code:	567-8680
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13223629
CORRESPONDENCE DATA	
Fax Number:	(202)293-7860
Phone:	202-293-7060
Email:	sughrue@sughrue.com
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Correspondent Name:	SUGHRUE MION, PLLC
Address Line 1:	2100 PENNSYLVANIA AVENUE, N.W.
Address Line 2:	SUITE 800
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20037
ATTORNEY DOCKET NUMBER:	Q126085
NAME OF SUBMITTER:	Perri Michael, New Applic. Specialist
Total Attachments: 1 source=ASSIGNMENT_AS_FILED#page1.tif	

OP \$40.00 13223629

501725246

PATENT
REEL: 027233 FRAME: 0356

Assignment

Whereas, We, Takashi HABU; Fumiteru ASAI; Tomokazu TAKAHASHI; Eiichi IMOTO; and Yuta SHIMAZAKI of Ibaraki-shi, Osaka hereinafter called assignors, have invented certain improvements in PRESSURE-SENSITIVE ADHESIVE SHEET FOR PROTECTING SEMICONDUCTOR WAFER and executed an application for Letters Patent of the United States of America therefor on _____; and

Whereas, NITTO DENKO CORPORATION of 1-1-2, Shimohozumi, Ibaraki-shi, Osaka 567-8680, Japan, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

We, the above named assignors, hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, including the right to claim priority under 35 U.S.C. §119, and we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

We hereby authorize and request our attorneys SUGHRUE MION, PLLC of 2100 Pennsylvania Avenue, NW, Washington, DC 20037-3213 to insert here in parentheses (Application number 13/223,629 and Confirmation number 7782, filed September 1, 2011) the application number and filing date of said application when known.

Date: 10.24.2011 Takashi Habu
s/Takashi HABU

Date: 10.24.2011 Fumiteru Asai
s/Fumiteru ASAI

Date: 10.24.2011 Tomokazu Takahashi
s/Tomokazu TAKAHASHI

Date: 10.19.2011 Eiichi Imoto
s/Eiichi IMOTO

Date: 10.25.2011 yuta Shimazaki
s/Yuta SHIMAZAKI

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. §261)